

Nov 1st, 2022

PCN # ESW490-46 - Alternate Assembly Location for IXYS Power Thyristor & Diode TO-220AB AC Package

To our valued customers,

Littelfuse would like to notify you that we qualified alternate assembly location for IXYS Power Thyristor & Diode TO-220AB_AC package products with BCP consideration. Detail affected product list please refer to attached file.

All affected products have been fully qualified in accordance with established performance and reliability criteria. The attached pages summarize the qualification results. Full qualification data and/or samples will be available upon request.

Form, fit, function changes: Slight dimension difference but all in JEDEC spec

Part number changes: None Effective date: Feb 1st, 2023 Replacement products: N/A

Last time buy: N/A

This notification is for your information and acknowledgement. If you have any other questions or concerns, please contact your local sales team or Zhiwei Wang, Power Thyristor/Diode Discrete, Product Marketing Manager.

We value your business and look forward to assisting you whenever possible.

Thank you very much!

Best Regards,

Zhiwei Wang
Product Marketing Manager of Power Thyristor/Diode Discrete
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800 E. Northwest Highway Des Plaines, IL 60016

Product/Process Change Notice (PCN)

PCN#: ESW490-46 Date: Nov 1st, 2022		Contact Information				
Product Identification:		Name: Zhiwei Wang				
Alternate Assembly Location for IXYS Power Thyristor & Diode TO-220AB_AC Package Implementation Date for Change:		Title: Product Marketing Manager				
		Phone #: +86 510 85277701 - 7927				
		Fax#: N/A				
Feb 1st, 2023		E-mail: zwang@littelfuse.com				
Category of Change:	Descri	ption of Change:				
☐ Assembly Process		would like to notify you that we qualified alternate assembly location				
☐ Data Sheet		YS Power Thyristor & Diode TO-220AB_AC package products with BCP				
☐ Technology		eration. Detail affected product list please refer to attached file.				
☐ Discontinuance/Obsolescence		cted products have been fully qualified in accordance with established nance and reliability criteria.				
☐ Equipment	•	it, function changes: Slight dimension difference but all in JEDEC spec				
☐ Raw Material		ımber changes: None				
☐ Testing	Effectiv	ve date: Feb 1st, 2023				
☐ Fabrication Process	Replac	ement products: N/A				
Other:	Last tin	ne buy: N/A				
Important Dates:						
□ Qualification Samples Available:		☐ Last Time Buy:				
☐ Date of Final Product Shipment:						
Method of Distinguishing Changed Pro	oduct					
☐ Product Mark,						
□ Date Code, Different Site Code						
☐ Other,						
Demonstrated or Anticipated Impact on Form, Fit, Function or Reliability:						
Slight dimension difference but all in JEDEC spec						
LF Qualification Plan/Results:						
All affected products have been fully qualified in accordance with established performance and reliability criteria.						
Customer Acknowledgement of Receipt: Littelfuse requests you acknowledge receipt of this PCN. In your acknowledgement, you can						
grant approval or request additional information. Littelfuse will assume the change is acceptable if no acknowledgement is received within 30 days						
of this notice. Lack of any additional response within 90 days of PCN issuance further constitutes acceptance of the change.						



PCN Report

Prepared By : Zhiwei Wang, Product Marketing Manager

Date : Nov 1st, 2022

Products : IXYS Power Thyristor/Diode TO-220AB_AC Package Products

Revision : A

1.0 Objective:

This qual report covers IXYS Power Thyristor/Diode TO-220AB_AC Package Products Alternative Assembly location qualification.

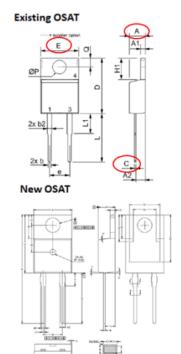
2.0 Applicable Products:

IXYS Power Thyristor/Diode TO-220AB_AC Package Products. Refer to Appendix A for detail part number list.

3.0 Physical Differences/Changes:

> Comparation of Package Detail Dimension between Existing Assy Site and Alternative Assy Site.

TO-220AC POD SPEC gap in A, C&E. But the actual measurement data all within Littelfuse SPEC.



Itama	Existing OSAT		Items	New	OSAT	New OSAT Actual Data			
Items	Min	Max	items	Min	Max	Min	Ave.	Max	
Α	4.32	4.82	Р	4.19	4.70	4.40	4.46	4.51	
A1	1.14	1.39	Q	1.22	1.37	1.26	1.28	1.30	
A2	2.29	2.79	V	2.38	2.80	2.56	2.58	2.61	
b	0.64	1.01	L1	0.63	0.92	0.83	0.84	0.85	
b2	1.15	1.65	M1	1.14	1.40	1.28	1.30	1.31	
С	0.35	0.56	W	0.35	0.64	0.46	0.48	0.50	
D	14.73	16.00	Е	14.98	15.62	15.25	15.30	15.36	
E	9.91	10.66	Α	9.67	10.42	10.17	10.21	10.26	
е	5.08	BSC	N	4.95	5.21	5.06	5.08	5.11	
H1	5.85	6.85	В	5.96	6.48	6.21	6.23	6.25	
L	12.70	13.97	Н	12.71	13.97	13.30	13.37	13.42	
L1	2.79	5.84	Z	3.30	3.81	3.39	3.48	3.70	
ФР	3.54	4.08	ФF	3.63	3.89	3.78	3.83	3.87	
Q	2.54	3.18	С	2.54	3.05	2.68	2.73	2.77	



TO-220AB POD SPEC gap in A, b1, D,D1,D2,E1,L,P,Q,D-Q,D+L1-Q.

Existing OSAT		Existing OSAT		New OSAT		New OSAT measurement data		ata
Top View Side View Bottom View	Sym	Min	Max	Min	Max	Min	AVG	Max
[[[]] - [] -	Α	4.3	4.7	4.2	4.6	4.36	4.42	4.46
	A1	1.2	1.4	1.2	1.4	1.30	1.31	1.32
	A2	2	2.7	2.2	2.6	2.36	2.39	2.46
	b	0.6	1	0.65	0.85	0.70	0.71	0.73
	b1	1.15	1.45	0.95	1.15	1.05	1.06	1.07
	с	0.35	0.65	0.4	0.6	0.49	0.50	0.51
1 - Gate	D	14.9	15.9	15.35	15.95	15.71	15.74	15.79
2.4 - Drain 3 - Source	D1	8.5	9.4	9.05	9.45	9.25	9.28	9.31
	D2	12.7	13.5	12.25	13.65	12.9	12.95	13.03
New OSAT	E	9.7	10.3	9.8	10.2	9.90	9.97	10.07
Top View Side View	E1	7.2	8.2	8	9	8.46	8.50	8.60
	e	2.54		2.54		2.52	2.55	2.57
	e1	5.	08	5.	08	5.04	5.09	5.14
- 20 - 00 - 00 - 00 - 00 - 00 - 00 - 00	H1	6.2	6.8	6.2	6.6	6.46	6.47	6.48
	L	12.5	13.9	13	14	13.43	13.48	13.55
	Р	3.4	3.8	3.55	3.85	3.66	3.70	3.77
C 12-4	Q	2.7	3.2	2.6	3	2.72	2.81	2.87
	D-Q	11.7	13.2	12.35	13.35	12.99	12.93	12.92
	L1(Modified)	2.8	3.9	2.8	3.9	2.92	2.99	3.05
1 - 1 - 2 × 1 - 1 - 2 ×	D+L1-Q(Modified)	14.5	17.1	15.15	17.25	15.91	15.92	15.97

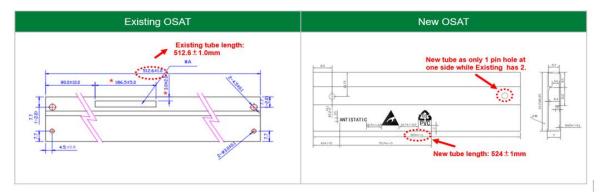
Conclusion: The variance is not critical which has no significant impact on customer application.

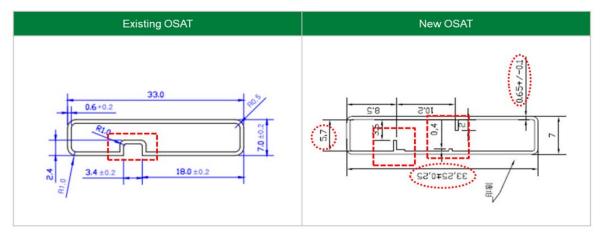
Comparison in detail Packing Spec between Existing Assy Site and Alternative Assy Site Inner/Outer Box dimension & packing qty:

Item	Description	Existing OSAT	New OSAT
1	Size of Inner Box	568*155*55mm	565*105*43mm
2	Size of Outer box	586*230*167mm	585*235*119mm
3	Size of Tube	512.6*33mm	534.5*33mm
4	Packing Qty perTube	50 pcs	50 pcs
5	Packing Qty per Inner Box	1000 pcs	500 pcs
6	Packing Qty per Outer Box	8000 pcs	2500 pcs



Tube dimension:





Conclusion:

- Inner/Outer Box dimension & packing qty: Alternative Assy site's packing box is smaller than existing Assy site which lead to less packing qty. But it does not affect the MOQ.
- Tube dimension: Alternative Assy site's packing tube for TO-220 is different from existing Assy site. The difference may or may not impact the device unloading at customer side.

4.0 Qualification Test Result

All samples passed parametric and reliability test standard by Littelfuse.

	TO-220 Thyristor & Diode Qualification Summary						
	Supp						ıc
Pac	kage Type: TO-22	0			Family 1	Type: Power	Thyristor & Diode
#	Abrv	Sample P/N	Condition	Littelfuse Test Ref#	# of lot	Sample Qty	Results
1	TC	DSP8-08&12A	100 cycles, -55°C/150°C	Q11-8128	2	20	0 Failure
2	UHAST	DSP8-08&12A	96 h, 130°C, 85%RH	ETR168707	2	20	0 Failure
3	PC	DSP8-08&12A	4000 cycles, I_TAV=8A, I_TRMS=16A, P~14,8W, T_J=145°C, dT=100K, T_H=45-115,5°C, t_on=83s, t_off=64s	Q11-8128	2	20	0 Failure
4	HTRB	DSP8-08&12A	1000hrs, 150°C, 840 V AC	Q11-8128	2	20	0 Failure
5	Surge Current	DSP8-08&12A	120A, 10ms	Q11-8128	2	3	0 Failure
6	RSH	DSP8-08&12A	Tdwell=10 sec @ 260°C	Q11-8128	2	10	0 Failure
7	Solderability	DSP8-08&12A	5ea for method B(standard process, low temp) & method D	Q11-8128	2	5	0 Failure



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1	TC	DSI30-8/16A	100 cycles, -40°C/150°C	Q11-8129	2	20	0 Failure
2	UHAST	DSI30-8/16A	96 h, 130°C, 85%RH	ETR175375	2	20	0 Failure
3	PC	DSI30-8/16A	4000 cycles, I_TAV=21A, I_TRMS=39A, P~38,7W, T_J=145°C, dT=100K, T_H=45-75,4,1°C, t_on=55s, t_off=55s	Q11-8129	2	20	0 Failure
4	HTRB	DSI30-8/16A	1000h, 150 °C, 1120 V AC	Q11-8129	2	20	0 Failure
5	Surge Current	DSI30-8/16A	300A, 10ms	Q11-8129	2	3	0 Failure
6	RSH	DSI30-8/16A	Tdwell=10 sec @ 260°C	Q11-8129	2	10	0 Failure
7	Solderability	DSI30-8/16A	5ea for method B(standard process, low temp) & method D	Q11-8129	2	5	0 Failure
1	TC	DSEP 12-12A	100 cycles, -55°C/150°C; EOL	Q11-8130	2	20	0 Failure
2	UHAST	DSEP 12-12A	96 h, 130°C, 85%RH	ETR175377	2	20	0 Failure
3	PC	DSEP 12-12A	4000 cycles, I=6A DC, P~7,5W/Chip, T_J=145°C, dT=100K,T_H=45-129°C, t_on=55s, t_off=40s	Q11-8130	2	20	0 Failure
4	HTRB	DSEP 12-12A	1000 hrs, 150°C, 960V DC	Q11-8130	2	20	0 Failure
5	Surge Current	DSEP 12-12A	90A, 10ms	Q11-8130	2	3	0 Failure
6	RSH	DSEP 12-12A	Tdwell=10 sec @ 260°C	Q11-8130	2	10	0 Failure
7	Solderability	DSEP 12-12A	5ea for method B(standard process, low temp) & method D	Q11-8130	2	5	0 Failure
		•					•
1	TC	CS19-12HO1	200 cycles, -40°C/150°C; EOL	Q11-8132	2	20	0 Failure
2	UHAST	CS19-12HO1	96 h, 130°C, 85%RH	ETR168708	2	20	0 Failure
3	PC	CS19-12HO1	4000 cycles, IL = 18A, P~38W, T_J = 125°C, dT = 80°C ton = 62sec, toff = 67sec	Q11-8132	2	20	0 Failure
4	HTRB	CS19-12HO1	1000hrs, 125°C, 840VAC mounted on heatsink	Q11-8132	2	20	0 Failure
5	Surge Current	CS19-12HO1	180A, t = 10ms, 50Hz	Q11-8132	2	3	0 Failure
6	RSH	CS19-12HO1	Tdwell=10 sec @ 260°C	Q11-8132	2	10	0 Failure
7	Solderability	CS19-12HO1	5ea for method B(standard process, low temp) & method D	Q11-8132	2	5	0 Failure
1	TC	DHG10I1800PA	100 cycles, -55/150 °C, EOL	Q11-8201	2	20	0 Failure
2	UHAST	DHG10I1800PA	96 h, 130°C, 85%RH	ETR175378	2	20	0 Failure
3	PC	DHG10I1800PA	4000 cycles, I=5A DC, P~8,4W/Chip, T_J=145°C, dT=100K,T_H=45-128°C, t_on=55s, t_off=50s	Q11-8201	2	20	0 Failure
4	HTRB	DHG10I1800PA	1000hrs ,150°C, 1440V DC	Q11-8201	2	20	0 Failure
5	Surge Current	DHG10I1800PA	60A, 10ms	Q11-8201	2	3	0 Failure
6	RSH	DHG10I1800PA	Tdwell=10 sec @ 260°C	Q11-8201	2	10	0 Failure
7	Solderability	DHG10I1800PA	5ea for method B(standard process, low temp) & method D	Q11-8201	2	5	0 Failure
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5.0 Recommendations & Conclusions:

Based on the above qualification test results, Littelfuse concluded new Alternative Assembly Location can pass the release criterion and ready to start mass production for affected products.



Appendix A: Detail Part Number list affected

Material	Package
CS19-12HO1	TO-220AB
DHG10I1800PA	TO-220AB
DSEP12-12A	TO-220AC
CS19-12HO1	TO-220AB
CLA15E1200NPB	TO-220AB
CLA20EF1200PB	TO-220AB
CLA30E1200PB	TO-220AB
CLA30MT1200NPB	TO-220AB
CLA40MT1200NPB	TO-220AB
CLE30E1200PB	TO-220AB
CMA20E1600PB	TO-220AB
CMA30E1600PB	TO-220AB
CS19-08HO1	TO-220AB
DHG10C600PB	TO-220AB
DHG10I1200PA	TO-220AC
DHG10I600PA	TO-220AC
DHG20C1200PB	TO-220AB
DHG20C600PB	TO-220AB
DHG20I1200PA	TO-220AC
DHG20I600PA	TO-220AC
DHG30I600PA	TO-220AC
DHG40C600PB	TO-220AB
DHG5I600PA	TO-220AC
DMA10I1600PA	TO-220AC
DNA30E2200PA	TO-220AC
DPF30I300PA	TO-220AC
DPG10I200PA	TO-220AC
DPG10I300PA	TO-220AC
DPG10I400PA	TO-220AC
DPG15I200PA	TO-220AC
DPG15I300PA	TO-220AC
DPG20C200PB	TO-220AB

DPG20C300PB	TO-220AB
DPG20C400PB	TO-220AB
DPG30C200PB	TO-220AB
DPG30C300PB	TO-220AB
DPG30C400PB	TO-220AB
DPG30I300PA	TO-220AC
DSEC16-06A	TO-220AB
DSEC16-12A	TO-220AB
DSEI12-06A	TO-220AC
DSEI12-10A	TO-220AC
DSEI12-12A	TO-220AC
DSEI20-12A	TO-220AC
DSEI25-06A	TO-220AC
DSEI8-06A	TO-220AC
DSEP12-12B	TO-220AC
DSEP15-06A	TO-220AC
DSEP15-06B	TO-220AC
DSEP29-06A	TO-220AC
DSEP29-06B	TO-220AC
DSEP29-12A	TO-220AC
DSEP29-12B	TO-220AC
DSEP8-06A	TO-220AC
DSEP8-06B	TO-220AC
DSEP8-12A	TO-220AC
DSI30-08A	TO-220AC
DSI30-12A	TO-220AC
DSI30-16A	TO-220AC
DSP8-08A	TO-220AB
DSP8-12A	TO-220AB
DSEP15-03A	TO-220AB
DSEP29-03A	TO-220AB
DSI30-16A	TO-220AC
DSP8-12A	TO-220AB